

**SPECIFICATIONS**

Rated Current:3.0AMP  
 Contact Resistance:20mΩ Max  
 Withstand Voltage:1000V AC/DC  
 Insulation Resistance:1000MΩ Min  
 Operation Temperature:-40°c to +105°c

Contact Material:Brass  
 Contact Plating:Au or Sn Over Ni  
 Insulator Material:Polyester(UL94V-0)  
 Resistance To Soldering Heat:  
 245° C ±5° C, 10s(PBT insulator)  
 260° C ±5° C, 10s(PA6T&PA9T&LCP insulator)

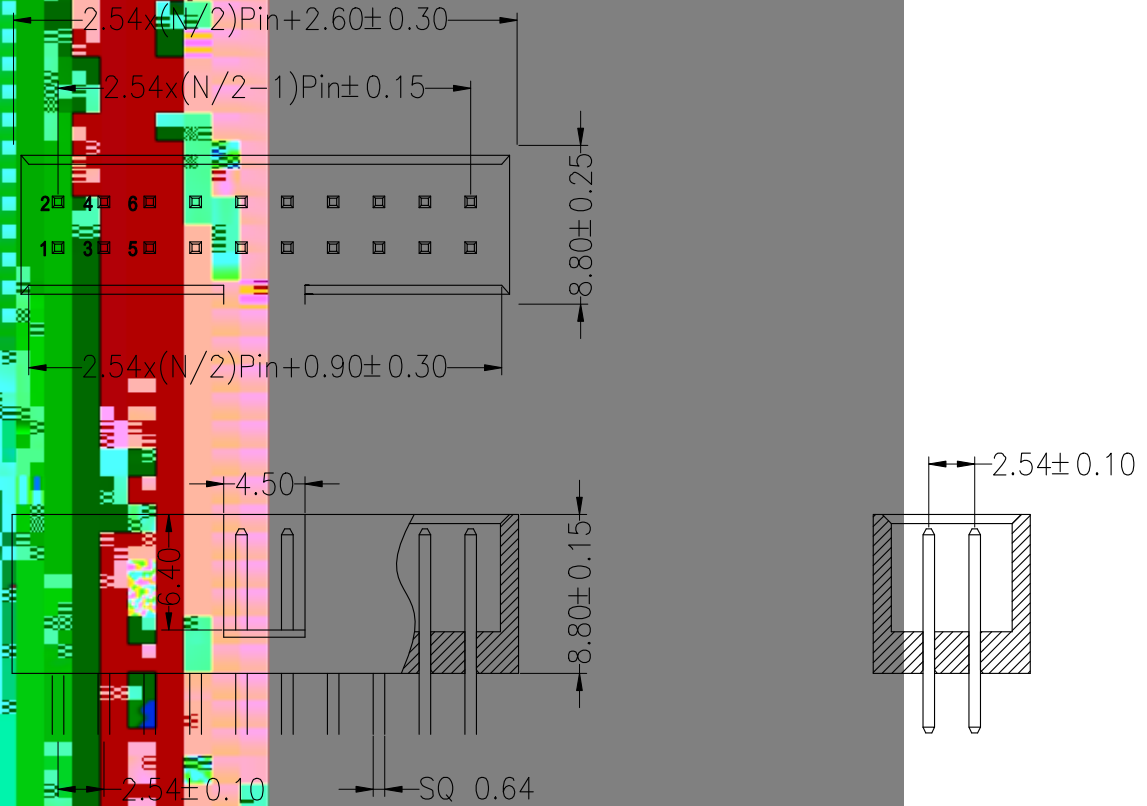
**Ordering Information**

**3213 XX S XX X B K00 X 0X**

Contact Plating  
 G0:Gold Flash  
 G1:1u" Gold  
 G2:1.5u" Gold  
 G3:2u" Gold  
 G4:3u" Gold  
 G5:5u" Gold  
 G6:10u" Gold  
 G7:15u" Gold  
 G8:30u" Gold  
 S0:Gold Flash/Tin  
 SN:Tin

Insulator Material  
 Option  
 C=BK-PA6T  
 E=T

Recommended P.C.B Layout(Top Side)  
 (PCB BOARD TOLERANCE±0.05)



				OPERATION	DRAW	Jelly Feng	22.07.01	SCALE	FIT		
				X.X ±0.30				UNIT	mm		
				X.XX ±0.20	CHECK			SIZE	A4	PART NO.	3213XXSXXBK00X0X
A0	2022.07.01	NEW DRAWING		X.XXX ±0.10				SHEET	1/1		
REV	DATE	MODIFICATION DESCRIPTION		Angle ±3°	APPROVE			PROJ.	☉	TITLE:	2.54mm Box Header H8.8mm 180° 短体
				DIM	TOL						